PRODUCT CHANGE NOTICE				
PART NUMBER(S):	PCN No.: 06-0130-03a			
Please see attachment.	DATE: June 23, 2006			
PART DESCRIPTION:				
Power Management and Interface Products – Change in Wafer Fabrication Site				
LEVEL OF CHANGE:				
[X] Level I, Customer Approval.	[] Level II, Customer Information.			
PRODUCT ATTRIBUTE AFFECTED:				
[] Material Change [] Design Change [X] Process Change	Data Sheet Change Package Change Packing / Shipping			
[X] Other, Explain: Wafer Fabrication Site Transfer				
DESCRIPTION OF CHANGE:				
Announcing transfer of certain Power Management and Interface Products from Hillview wafer fabrication facility to wafer foundry EPISIL. See attached Product List no. 03a.				
REASON FOR CHANGE:				
Power Management and Interface products as listed are being transferred to external wafer foundry, due to cessation of operations of the Sipex Hillview Wafer Fabrication manufacturing site.				

FABRICATION PROCESS QUALIFICATION

COMPLETED (DATE): October 31, 2006

PRODUCT CHARACTERIZATION COMPLETED AND

SAMPLES* AVAILABLE (DATE): December 30, 2006

^{*} Samples representative of product from the Product Family being transferred.



PRODUCT CHANGE NOTICE				
EARLIEST DATE OF PRODUCTION SHIPMENTS: December 30, 2006	N			
EFFECTIVITY CHANGE DATE OR	DATE CODE:	Work week assoc	iated wit	h earliest production shipment.
[] STANDARD DISTRIBUTION			[X]	CUSTOM DISTRIBUTION
PERSON TO CONTACT WITH QUE	ESTIONS:			
Fred Claussen				
VP Quality Assurance and Reliability Sipex Corporation Phone Number: 408-935-7644 FAX NUMBER: 408-935-7678	/			



PRODUCT CHANGE NOTICE

PCN No.: 06-0130-03a

List 3

SP3203CA

SP3203CA-L

SP3203CY

SP3203CY-L

SP3203EA

SP3203EA-L

SP3203ECA

SP3203ECA-L

SP3203ECY

SP3203ECY-L

SP3203EEA

SP3203EEA-L

SP3203EEY

SP3203EEY-L

SP3203EY

SP3203EY-L